

ISL21060 Precision Reference with Disable

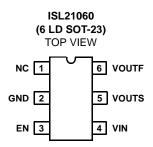
Data Sheet September 30, 2009 FN6706.4

Precision, Low Noise FGA™ Voltage References

The ISL21060 FGA[™] voltage references are low power, high precision voltage references fabricated on Intersil's proprietary Floating Gate Analog technology. A new disable feature allows the device to shut down the output and reduce supply current drain from 15µA operating to <500nA.

The ISL21060 family features guaranteed initial accuracy as low as ± 1.0 mV with drift down to 10ppm/°C. Noise is typically $10\mu V_{P-P}$ (10Hz BW). This combination of high initial accuracy, low power and low output noise performance of the ISL21060 enables versatile high performance control and data acquisition applications with low power consumption.

Pinout



Features

• Reference Output Voltage 2.048V, 2.500V, 3.000V, 3.300V, 4.096V
• Initial Accuracy
 Input Voltage Range ISL21060-20
• Output Voltage Noise 10µV _{P-P} (0.1Hz to 10Hz)
• Supply Current
• Tempco10ppm/°C, 25ppm/°C
Output Current Capability +10.0mA/-5mA
• Operating Temperature Range40°C to +125°C
• Package
Pb-Free (RoHS compliant)

Applications

- · High Resolution A/Ds and D/As
- · Digital Meters
- Bar Code Scanners
- Basestations
- · Battery Management/Monitoring
- Industrial/Instrumentation Equipment

Pin Descriptions

PIN NUMBER	PIN NAME	DESCRIPTION
1	NC	No Connect; Do Not Connect
2	GND	Ground Connection
3	EN	Enable Input. Active High. Do not Float.
4	VIN	Input Voltage Connection
5	VOUTS	Voltage Reference Output Connection (Sense)
6	VOUTF	Voltage Reference Output Connection (Force)

Ordering Information

PART NUMBER (Note)	PART MARKING	V _{OUT} OPTION (V)	GRADE (mV)	TEMP. RANGE (ppm/°C)	PACKAGE (Pb-Free)	PKG. DWG. #
ISL21060BFH620Z-TK*	GACB	2.048	1.0	10	6 Ld SOT-23	MDP0038
ISL21060CFH620Z-TK*	GACD	2.048	2.5	25	6 Ld SOT-23	MDP0038
ISL21060BFH625Z-TK*	GAEA	2.500	1.0	10	6 Ld SOT-23	MDP0038
ISL21060CFH625Z-TK*	GAGA	2.500	2.5	25	6 Ld SOT-23	MDP0038
ISL21060BFH630Z-TK*	GAHA	3.000	1.0	10	6 Ld SOT-23	MDP0038
ISL21060CFH630Z-TK*	GAJA	3.000	2.5	25	6 Ld SOT-23	MDP0038
ISL21060CFH633Z-TK*	GAPA	3.300	2.5	25	6 Ld SOT-23	MDP0038
ISL21060BFH641Z-TK*	GACC	4.096	1.0	10	6 Ld SOT-23	MDP0038
ISL21060CFH641Z-TK*	GACE	4.096	2.5	25	6 Ld SOT-23	MDP0038

^{*}Please refer to TB347 for details on reel specifications.

NOTE: These Intersil Pb-free plastic packaged products employ special Pb-free material sets, molding compounds/die attach materials, and 100% matte tin plate plus anneal (e3 termination finish, which is RoHS compliant and compatible with both SnPb and Pb-free soldering operations). Intersil Pb-free products are MSL classified at Pb-free peak reflow temperatures that meet or exceed the Pb-free requirements of IPC/JEDEC J STD-020.

Absolute Voltage Ratings

Max Voltage	
V _{IN} to GND0.5V to	+6.5V
V _{OUT} to GND (10s)0.5V to V _{OU}	_{JT} + 1V
Voltage on "DNC" pins No connections permitted to the	se pins
ESD Rating	
Human Body Model	.5500V
Machine Model	550V
Charged Device Model	2kV

Thermal Information

Thermal Resistance (Typical, Note 1)	θ _{JA} (°C/W)
6 Ld SOT-23	230
Continuous Power Dissipation ($T_A = +70$ °C, Note 3)	
Storage Temperature Range65°	°C to +150°C
6 Ld SOT-23, derate	
5.88mW/°C above +70°C	471mW
Pb-free Reflow Profile (Note 2)s	ee link below
http://www.intersil.com/pbfree/Pb-FreeReflow.asp	

Recommended Operating Conditions

Temperature Range (Industrial) -40°C to +125°C

CAUTION: Do not operate at or near the maximum ratings listed for extended periods of time. Exposure to such conditions may adversely impact product reliability and result in failures not covered by warranty.

IMPORTANT NOTE: All parameters having Min/Max specifications are guaranteed. Typ values are for information purposes only. Unless otherwise noted, all tests are at the specified temperature and are pulsed tests, therefore: $T_J = T_C = T_A$

NOTE

- 1. θ_{JA} is measured with the component mounted on a high effective thermal conductivity test board in free air. See Tech Brief TB379 for details.
- 2. Post-reflow drift for the ISL21060 devices will range from 100µV to 1.0mV based on experimental results with devices tested in sockets and also on FR4 multi-layer PC boards. The design engineer must take this into account when considering the reference voltage after assembly.

Electrical Specifications (ISL21060-20, V_{OUT} = 2.048V) V_{IN} = 3.0V, T_A = -40°C to +125°C, I_{OUT} = 0, unless otherwise specified.

PARAMETER	DESCRIPTION	CONDITIONS	MIN	TYP	MAX	UNIT
V _{OUT}	Output Voltage			2.048		V
V _{OA}	V _{OUT} Accuracy @ T _A = +25°C	ISL21060B20	-1.0		+1.0	mV
		ISL21060C20	-2.5		+2.5	mV
TC V _{OUT}	Output Voltage Temperature	ISL21060B			10	ppm/°C
	Coefficient (Note 3)	ISL21060C			25	ppm/°C
V _{IN}	Input Voltage Range		2.5		5.5	V
I _{IN}	Supply Current	V _{EN} = V _{IN}		16	40	μA
$\Delta V_{OUT} / \Delta V_{IN}$	Line Regulation	2.5V ≤ V _{IN} ≤ 5.5V		50	150	μV/V
$\Delta V_{OUT}/\Delta I_{OUT}$	Load Regulation	Sourcing: 0mA ≤ I _{OUT} ≤ 10mA		3	50	μV/mA
		Sinking: $-5mA \le I_{OUT} \le 0mA$		150	400	μV/mA
I _{SC}	Short Circuit Current	T _A = +25°C, V _{OUT} tied to GND		50		mA
t _R	Turn-on Settling Time	V _{OUT} = ±0.1%		300		μs
	Ripple Rejection	f = 10kHz		75		dB
e _N	Output Voltage Noise	$0.1Hz \le f \le 10Hz$		10		μV _{P-P}
V _N	Broadband Voltage Noise	$10Hz \le f \le 1kHz$		2.5		μV_{RMS}
	Noise Density	f = 1kHz		60		nV/√Hz
$\Delta V_{OUT}/\Delta T_{A}$	Thermal Hysteresis (Note 4)	$\Delta T_A = +165$ °C		100		ppm
$\Delta V_{OUT}/\Delta t$	Long Term Stability (Note 5)	T _A = +25°C		100		ppm
OUTPUT DISAB	LE	·	· · · · · · · · · · · · · · · · · · ·	1		·
V _{ENH}	Enable Logic High (ON)		1.6			V
V _{ENL}	Enable Logic Low (OFF)				0.8	V
I _{INSD}	Shutdown Supply Current	V _{EN} ≤ 0.35V		0.4	1.5	μΑ

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 $\textbf{Electrical Specifications} \qquad \textbf{(ISL21060-25, V}_{OUT} = \textbf{2.500V}) \quad V_{IN} = 3.0 \text{V}, \ T_{A} = -40 ^{\circ}\text{C to } +125 ^{\circ}\text{C}, \ I_{OUT} = 0, \ unless \ otherwise \ specified.}$

PARAMETER	DESCRIPTION	CONDITIONS	MIN	TYP	MAX	UNIT
V _{OUT}	Output Voltage			2.500		V
V _{OA}	V _{OUT} Accuracy @ T _A = +25°C	ISL21060B25	-1.0		+1.0	mV
		ISL21060C25	-2.5		+2.5	mV
TC V _{OUT}	Output Voltage Temperature	ISL21060B			10	ppm/°C
	Coefficient (Note 3)	ISL21060C			25	ppm/°C
V _{IN}	Input Voltage Range		2.7		5.5	V
I _{IN}	Supply Current	$V_{EN} = V_{IN}$		16	40	μA
$\Delta V_{OUT} / \Delta V_{IN}$	Line Regulation	$2.7V \le V_{IN} \le 5.5V$		50	150	μV/V
$\Delta V_{OUT}/\Delta I_{OUT}$	Load Regulation	Sourcing: $0mA \le I_{OUT} \le 10mA$		3	150	μV/mA
		Sinking: $-5mA \le I_{OUT} \le 0mA$		130	400	μV/mA
I _{SC}	Short Circuit Current	T _A = +25°C, V _{OUT} tied to GND		50		mA
t _R	Turn-on Settling Time	V _{OUT} = ±0.1%		300		μs
	Ripple Rejection	f = 10kHz		75		dB
e _N	Output Voltage Noise	$0.1Hz \leq f \leq 10Hz$		10		μV _{P-P}
V _N	Broadband Voltage Noise	$10Hz \le f \le 1kHz$		2.5		μV_{RMS}
	Noise Density	f = 1kHz		60		nV/√ Hz
$\Delta V_{OUT}/\Delta T_{A}$	Thermal Hysteresis (Note 4)	$\Delta T_A = +165$ °C		100		ppm
ΔV _{OUT} /Δt	Long Term Stability (Note 5)	T _A = +25°C		100		ppm
OUTPUT DISAB	LE	•	-			-
V _{ENH}	Enable Logic High (ON)		1.6			V
V _{ENL}	Enable Logic Low (OFF)				0.8	V
I _{INSD}	Shutdown Supply Current	$V_{EN} \le 0.35V$		0.4	1.5	μA

Electrical Specifications (ISL21060-30, $V_{OUT} = 3.000V$) $V_{IN} = 3.5V$, $T_A = -40^{\circ}C$ to +125°C, $I_{OUT} = 0$, unless otherwise specified.

PARAMETER	DESCRIPTION	CONDITIONS	MIN	TYP	MAX	UNIT
V _{OUT}	Output Voltage			3.000		V
V _{OA}	V _{OUT} Accuracy @ T _A = +25°C	ISL21060B30	-1.0		+1.0	mV
		ISL21060C30	-2.5		+2.5	mV
TC V _{OUT}	Output Voltage Temperature	ISL21060B			10	ppm/°C
Coefficient (Note 3)	Coefficient (Note 3)	ISL21060C			25	ppm/°C
V _{IN}	Input Voltage Range		3.2		5.5	V
I _{IN}	Supply Current	$V_{EN} = V_{IN}$		16	40	μA
$\Delta V_{OUT} / \Delta V_{IN}$	Line Regulation	$3.2 \text{V} \leq \text{V}_{\text{IN}} \leq 5.5 \text{V}$		50	150	μV/V
$\Delta V_{OUT}/\Delta I_{OUT}$	Load Regulation	Sourcing: $0mA \le I_{OUT} \le 10mA$		3	50	μV/mA
		Sinking: $-5mA \le I_{OUT} \le 0mA$		130	400	μV/mA
I _{SC}	Short Circuit Current	$T_A = +25$ °C, V_{OUT} tied to GND		50		mA
t _R	Turn-on Settling Time	V _{OUT} = ±0.1%		300		μs
	Ripple Rejection	f = 10kHz		75		dB
e _N	Output Voltage Noise	$0.1Hz \le f \le 10Hz$		10		μV _{P-P}
V _N	Broadband Voltage Noise	$10Hz \le f \le 1kHz$		2.5		μV_{RMS}

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Electrical Specifications (ISL21060-30, V_{OUT} = 3.000V) V_{IN} = 3.5V, T_A = -40°C to +125°C, I_{OUT} = 0, unless otherwise specified. (Continued)

PARAMETER	DESCRIPTION	CONDITIONS	MIN	TYP	MAX	UNIT
	Noise Density	f = 1kHz		60		nV/√Hz
$\Delta V_{OUT}/\Delta T_{A}$	Thermal Hysteresis (Note 4)	$\Delta T_A = +165$ °C		100		ppm
ΔV _{OUT} /Δt	Long Term Stability (Note 5)	T _A = +25°C		100		ppm
OUTPUT DISABI	LE					•
V _{ENH}	Enable Logic High (ON)		1.6			V
V _{ENL}	Enable Logic Low (OFF)				0.8	V
I _{INSD}	Shutdown Supply Current	V _{EN} ≤ 0.35V		0.4	1.5	μA

Electrical Specifications (ISL21060-33, V_{OUT} = 3.300V) V_{IN} = 5.0V, T_A = -40°C to +125°C, I_{OUT} = 0, unless otherwise specified.

PARAMETER	DESCRIPTION	CONDITIONS	MIN	TYP	MAX	UNIT
V _{OUT}	Output Voltage			3.300		V
V _{OA}	V _{OUT} Accuracy @ T _A = +25°C	ISL21060C33	-2.5		+2.5	mV
TC V _{OUT}	Output Voltage Temperature Coefficient (Note 3)	ISL21060C			25	ppm/°C
V _{IN}	Input Voltage Range		3.5		5.5	V
I _{IN}	Supply Current	EN = V _{IN}		18	40	μA
$\Delta V_{OUT} / \Delta V_{IN}$	Line Regulation	$3.5V \le V_{IN} \le 5.5V$		20	150	μV/V
$\Delta V_{OUT}/\Delta I_{OUT}$	Load Regulation	Sourcing: $0mA \le I_{OUT} \le 10mA$		10	50	μV/mA
		Sinking: $-5mA \le I_{OUT} \le 0mA$		120	400	μV/mA
I _{SC}	Short Circuit Current	T _A = +25°C, V _{OUT} tied to GND		50		mA
t _R	Turn-on Settling Time	V _{OUT} = ±0.1%		300		μs
	Ripple Rejection	f = 10kHz		75		dB
e _N	Output Voltage Noise	0.1Hz ≤ f ≤ 10Hz		10		μV _{P-P}
V _N	Broadband Voltage Noise	$10Hz \le f \le 1kHz$		2.5		μV _{RMS}
	Noise Density	f = 1kHz		60		nV/√Hz
$\Delta V_{OUT}/\Delta T_{A}$	Thermal Hysteresis (Note 4)	$\Delta T_A = +165$ °C		100		ppm
ΔV _{OUT} /Δt	Long Term Stability (Note 5)	T _A = +25°C		100		ppm
OUTPUT DISABL	E		•			
V _{ENH}	Enable Logic High (ON)		1.6			٧
V _{ENL}	Enable Logic Low (OFF)				0.8	V
I _{INSD}	Shutdown Supply Current	$V_{EN} \le 0.35V$		0.4	1.5	μA

Electrical Specifications (ISL21060-41, V_{OUT} = 4.096V) V_{IN} = 5.0V, T_A = -40°C to +125°C, I_{OUT} = 0, unless otherwise specified.

PARAMETER	DESCRIPTION	CONDITIONS	MIN	TYP	MAX	UNIT
V _{OUT}	Output Voltage			4.096		V
V _{OA}	V _{OUT} Accuracy @ T _A = +25°C	ISL21060B41	-1.0		+1.0	mV
		ISL21060C41	-2.5		+2.5	mV
TC V _{OUT}	Output Voltage Temperature Coefficient	ISL21060B			10	ppm/°C
	(Note 3)	ISL21060C			25	ppm/°C
V _{IN}	Input Voltage Range		4.3		5.5	V
I _{IN}	Supply Current	EN = V _{IN}		20	40	μA
$\Delta V_{OUT} / \Delta V_{IN}$	Line Regulation	$4.3V \le V_{IN} \le 5.5V$		50	150	μV/V
$\Delta V_{OUT}/\Delta I_{OUT}$	Load Regulation	Sourcing: $0mA \le I_{OUT} \le 10mA$		10	50	μV/mA
		Sinking: $-5mA \le I_{OUT} \le 0mA$		130	400	μV/mA
I _{SC}	Short Circuit Current	T _A = +25°C, V _{OUT} tied to GND		50		mA
t _R	Turn-on Settling Time	V _{OUT} = ±0.1%		300		μs
	Ripple Rejection	f = 10kHz		75		dB
e _N	Output Voltage Noise	$0.1Hz \le f \le 10Hz$		10		μV _{P-P}
V _N	Broadband Voltage Noise	$10Hz \le f \le 1kHz$		2.5		μV_{RMS}
	Noise Density	f = 1kHz		60		nV/√Hz
$\Delta V_{OUT}/\Delta T_{A}$	Thermal Hysteresis (Note 4)	$\Delta T_A = +165$ °C		100		ppm
ΔV _{OUT} /Δt	Long Term Stability (Note 5)	T _A = +25°C		100		ppm
OUTPUT DISABL	.E		-			•
V _{ENH}	Enable Logic High (ON)		1.6			V
V _{ENL}	Enable Logic Low (OFF)				0.8	V
I _{INSD}	Shutdown Supply Current	V _{EN} ≤ 0.35V		0.4	1.5	μA
	I .	I.				

NOTES:

- 3. Over the specified temperature range. Temperature coefficient is measured by the box method whereby the change in V_{OUT} is divided by the temperature range; in this case, -40°C to +125°C = +165°C.
- 4. Thermal Hysteresis is the change of V_{OUT} measured @ T_A = +25°C after temperature cycling over a specified range, ΔT_A . V_{OUT} is read initially at T_A = +25°C for the device under test. The device is temperature cycled and a second V_{OUT} measurement is taken at +25°C. The difference between the initial V_{OUT} reading and the second V_{OUT} reading is then expressed in ppm. For Δ T_A = +165°C, the device under test is cycled from +25°C to +125°C to -40°C to +25°C.
- 5. Long term drift is logarithmic in nature and diminishes over time. Drift after the first 1000 hours will be approximately 10ppm/√1khrs.

Typical Performance Curves (ISL21060-30) (REXT = 100kΩ)

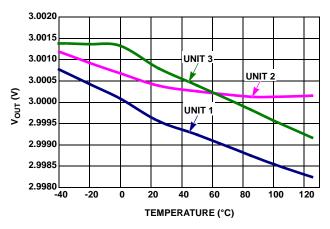


FIGURE 1. V_{OUT} vs TEMPERATURE, 3 UNITS

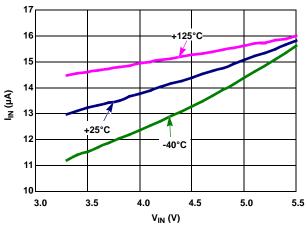


FIGURE 2. I_{IN} vs V_{IN} , 3 TEMPERATURES

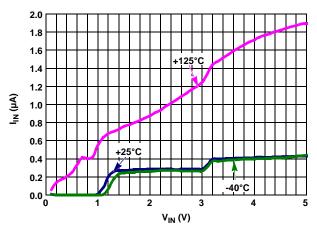


FIGURE 3. I_{IN} vs V_{IN} [SLEEP MODE], 3 TEMPERATURES

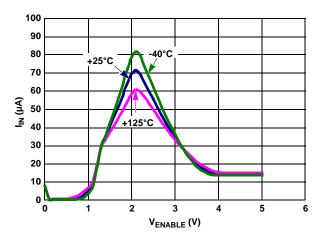


FIGURE 4. I_{IN} vs V_{ENABLE} , 3 TEMPERATURES

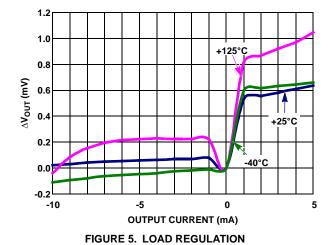
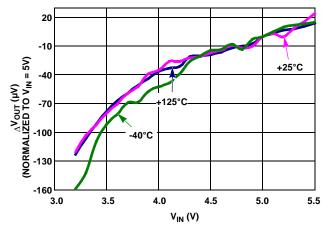


FIGURE 6. LINE REGULATION OVER-TEMPERATURE



Typical Performance Curves (ISL21060-30) (R_{EXT} = 100kΩ) (Continued)

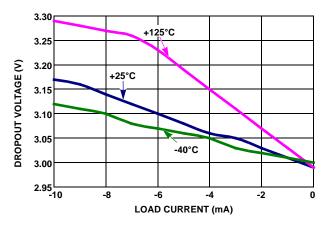


FIGURE 7. LOAD CURRENT vs DROPOUT

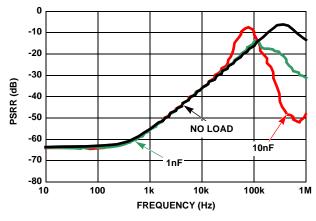


FIGURE 8. PSRR AT DIFFERENT CAPACITIVE LOADS

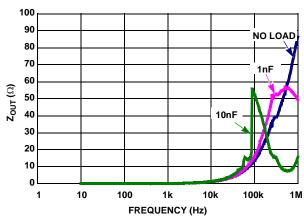


FIGURE 9. Z_{OUT} vs FREQUENCY

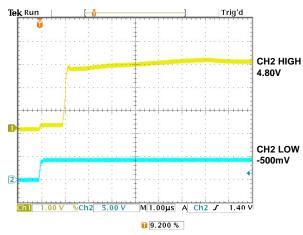


FIGURE 10. TURN-ON TIME, NO LOAD

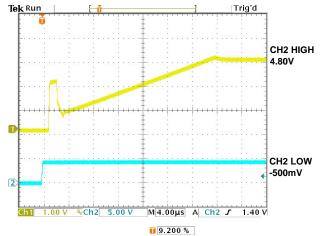


FIGURE 11. TURN-ON TIME, $1k\Omega$

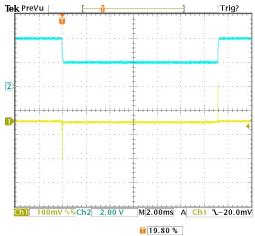


FIGURE 12. LOAD TRANSIENT RESPONSE, 1nF LOAD CAPACITANCE

Typical Performance Curves (ISL21060-30) (R_{EXT} = 100kΩ) (Continued)

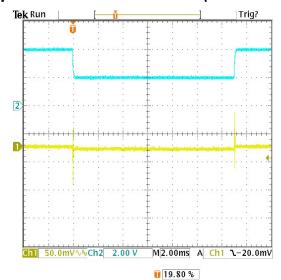


FIGURE 13. LOAD TRANSIENT RESPONSE, 100nF LOAD CAPACITANCE

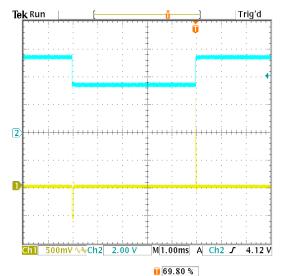


FIGURE 14. LINE TRANSIENT RESPONSE, 1nF LOAD

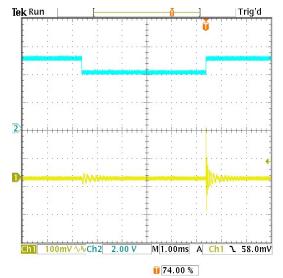


FIGURE 15. LINE TRANSIENT RESPONSE, 100nF

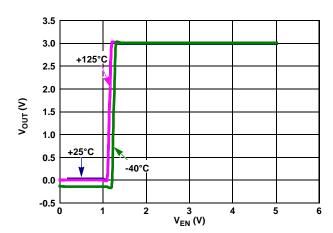


FIGURE 16. V_{OUT} vs V_{ENABLE}

Typical Performance Curves (ISL21060-41) (REXT = 100kΩ)

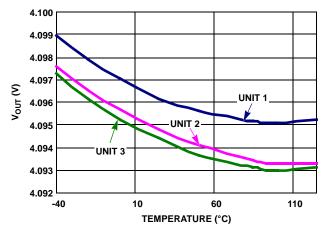


FIGURE 17. V_{OUT} vs TEMPERATURE, 3 UNITS

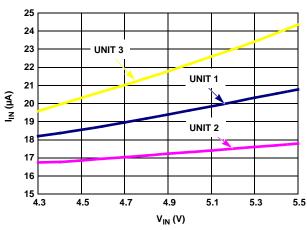


FIGURE 18. I_{IN} vs V_{IN}, 3 TEMPERATURES

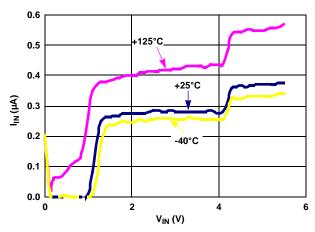


FIGURE 19. I_{IN} vs V_{IN}[SLEEP MODE], 3 TEMPERATURES

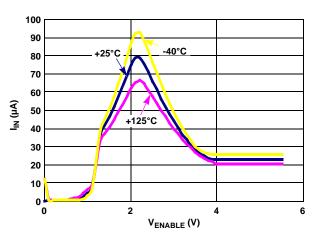


FIGURE 20. I_{IN} vs V_{ENABLE} , 3 TEMPERATURES

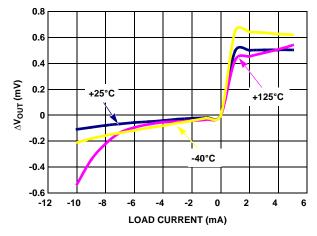


FIGURE 21. LOAD REGULATION

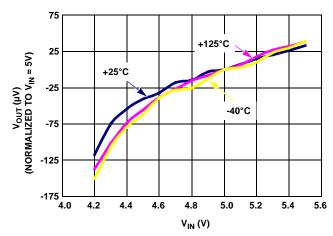


FIGURE 22. LINE REGULATION OVER-TEMPERATURE

Typical Performance Curves (ISL21060-41) (R_{EXT} = 100kΩ) (Continued)

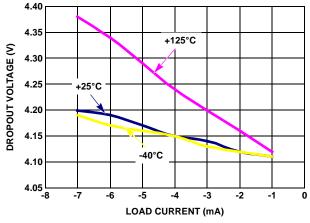


FIGURE 23. LOAD CURRENT vs DROPOUT

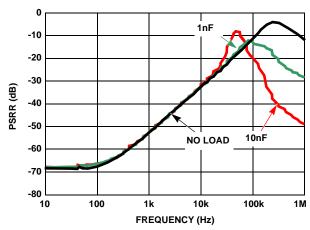


FIGURE 24. PSRR AT DIFFERENT CAPACITIVE LOADS

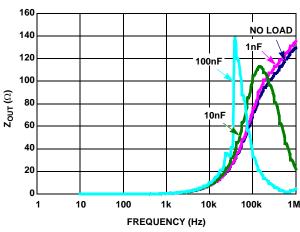
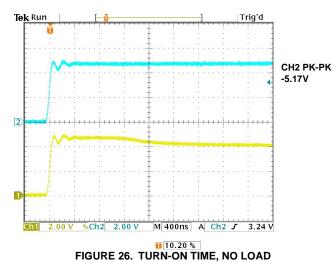


FIGURE 25. Z_{OUT} vs FREQUENCY



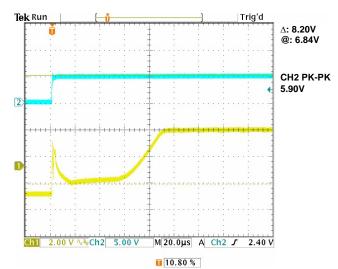


FIGURE 27. TURN-ON TIME, $1k\Omega$

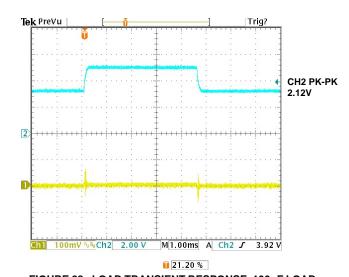


FIGURE 28. LOAD TRANSIENT RESPONSE, 100nF LOAD **CAPACITANCE**

Typical Performance Curves (ISL21060-41) (R_{EXT} = 100kΩ) (Continued)

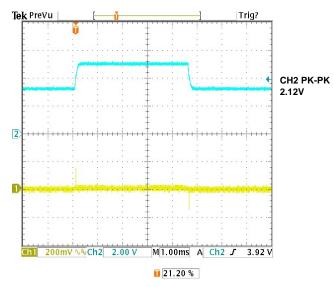


FIGURE 29. LOAD TRANSIENT RESPONSE, 1nF LOAD CAPACITANCE

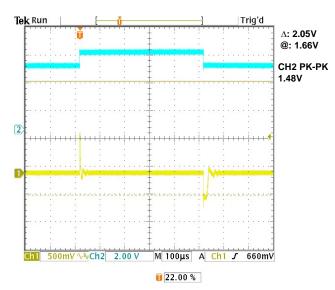


FIGURE 30. LINE TRANSIENT RESPONSE, 1nF LOAD

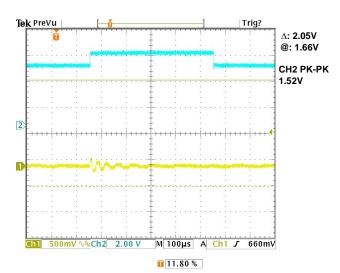


FIGURE 31. LINE TRANSIENT RESPONSE, 100nF LOAD **CAPACITANCE**

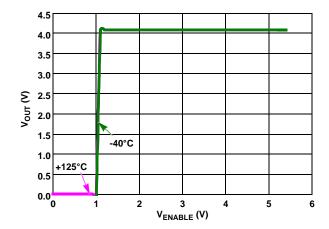


FIGURE 32. V_{OUT} vs V_{ENABLE}

12

Typical Performance Curves (ISL21060-25) (REXT = 100k\(\Omega))

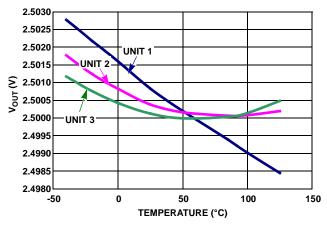


FIGURE 33. V_{OUT} vs TEMPERATURE, 3 UNITS

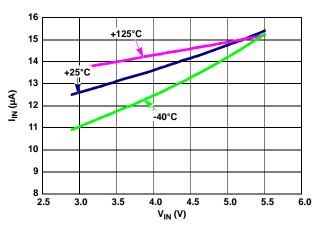


FIGURE 34. I_{IN} vs V_{IN} , 3 TEMPERATURES

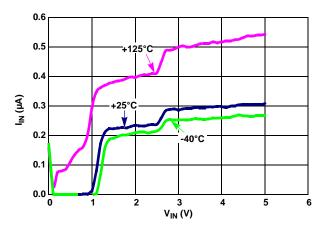


FIGURE 35. I_{IN} vs V_{IN} [SLEEP MODE], 3 TEMPERATURES

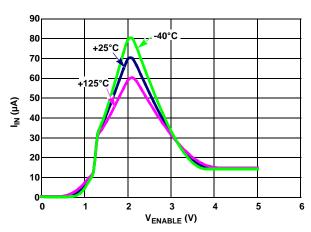


FIGURE 36. I_{IN} vs V_{ENABLE} , 3 TEMPERATURES

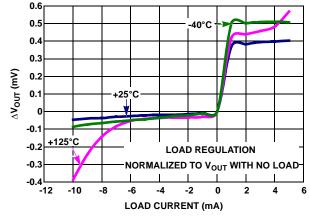


FIGURE 37. LOAD REGULATION

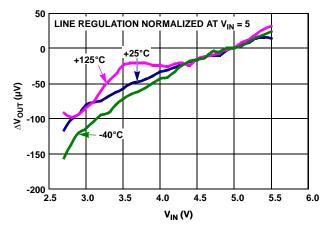


FIGURE 38. LINE REGULATION OVER-TEMPERATURE

Typical Performance Curves (ISL21060-25) (R_{EXT} = 100kΩ) (Continued)

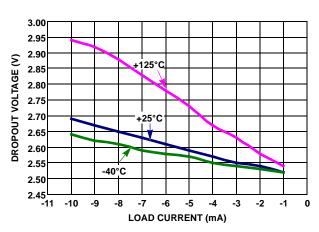


FIGURE 39. LOAD CURRENT vs DROPOUT

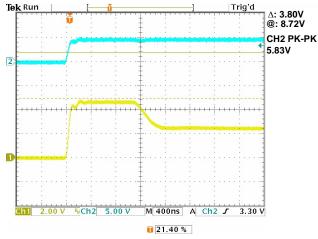


FIGURE 40. TURN-ON TIME, NO LOAD

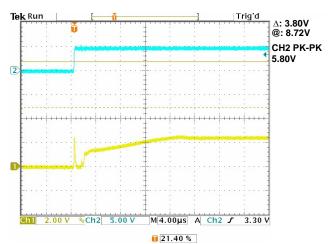


FIGURE 41. TURN-ON TIME, $1k\Omega$

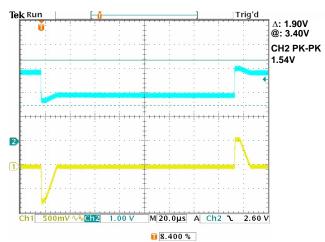


FIGURE 42. LOAD TRANSIENT RESPONSE, 1nF LOAD CAPACITANCE

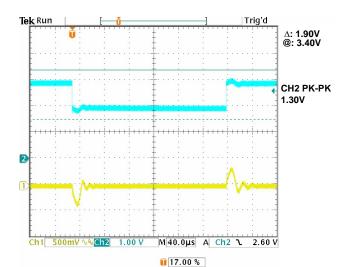


FIGURE 43. LOAD TRANSIENT RESPONSE, 100nF LOAD CAPACITANCE

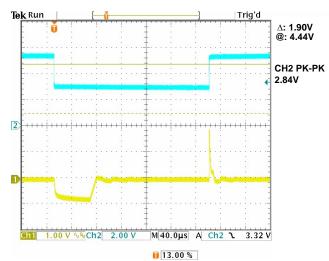
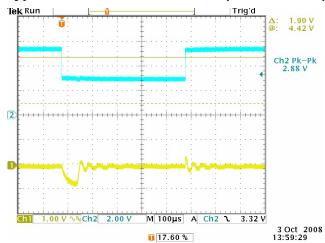


FIGURE 44. LINE TRANSIENT RESPONSE, 1nF LOAD

Typical Performance Curves (ISL21060-25) (R_{EXT} = 100kΩ) (Continued)



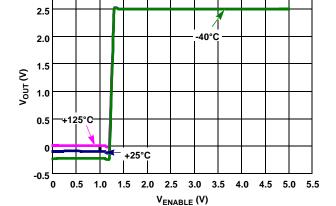
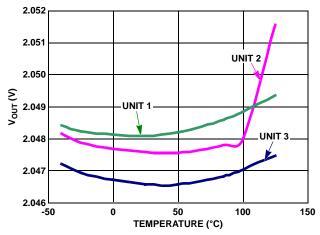


FIGURE 45. LINE TRANSIENT RESPONSE,100nF

FIGURE 46. V_{OUT} vs V_{ENABLE}

Typical Performance Curves (ISL21060-20) (R_{EXT} = 100kΩ)



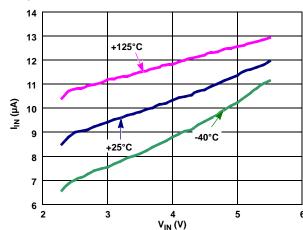
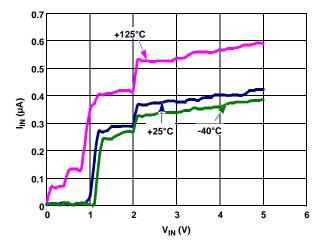


FIGURE 47. V_{OUT} vs TEMPERATURE, 3 UNITS

FIGURE 48. $I_{\rm IN}$ vs $V_{\rm IN}$, 3 TEMPERATURES



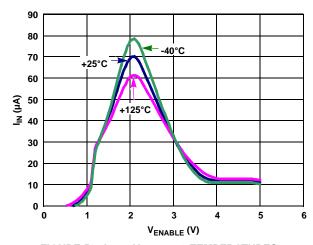


FIGURE 49. I_{IN} vs V_{IN} [SLEEP MODE], 3 TEMPERATURES

FIGURE 50. I_{IN} vs V_{ENABLE} , 3 TEMPERATURES

Typical Performance Curves (ISL21060-20) (R_{EXT} = 100kΩ) (Continued)

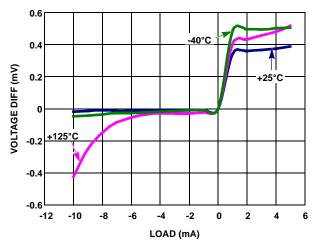


FIGURE 51. LOAD REGULATION

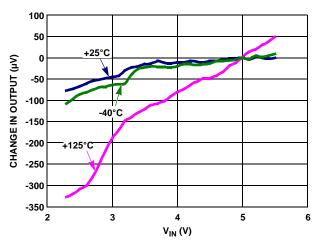


FIGURE 52. LINE REGULATION OVER-TEMPERATURE

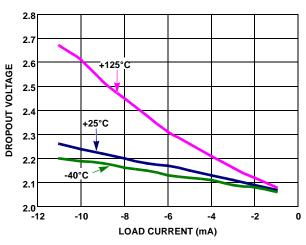


FIGURE 53. LOAD CURRENT vs DROPOUT

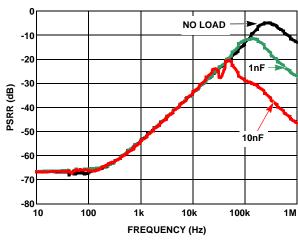


FIGURE 54. PSRR AT DIFFERENT CAPACITIVE LOADS

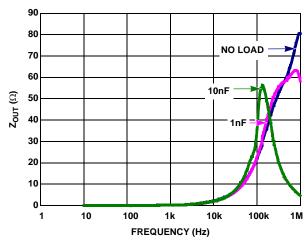


FIGURE 55. Z_{OUT} vs FREQUENCY

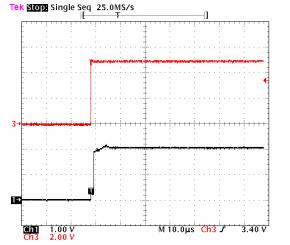
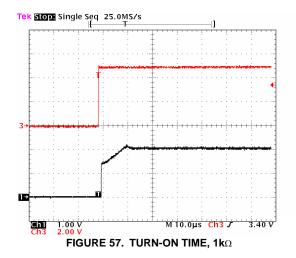


FIGURE 56. TURN-ON TIME, NO LOAD

Typical Performance Curves (ISL21060-20) ($R_{EXT} = 100k\Omega$) (Continued)



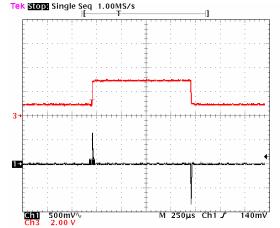


FIGURE 58. LOAD TRANSIENT RESPONSE, 1nF LOAD CAPACITANCE

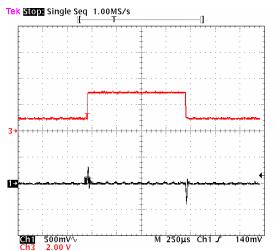


FIGURE 59. LOAD TRANSIENT RESPONSE, 100nF LOAD CAPACITANCE

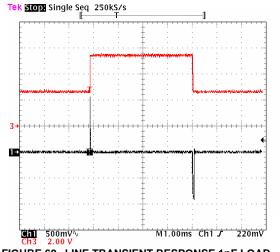
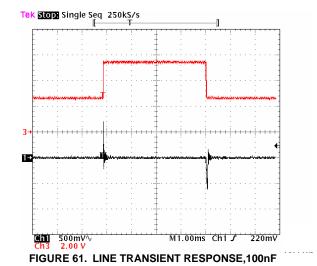


FIGURE 60. LINE TRANSIENT RESPONSE,1nF LOAD



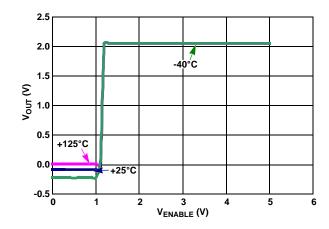


FIGURE 62. V_{OUT} vs V_{ENABLE}

FGA Technology

The ISL21060 voltage reference floating gate references possess very low drift and supply current. The charge stored on a floating gate cell is set precisely in manufacturing. The reference voltage output itself is a buffered version of the floating gate voltage. The resulting reference device has excellent characteristics which are unique in the industry and include very low temperature drift, high initial accuracy, and almost zero supply current. Also, the reference voltage itself is not limited by voltage bandgaps or zener settings, so a wide range of reference voltages can be programmed (standard voltage settings are provided, but customer-specific voltages are available).

The process used for these reference devices is a floating gate CMOS process, and the amplifier circuitry uses CMOS transistors for amplifier and output drive. This circuitry provides excellent accuracy with a trade-off in output noise level and load regulation due to the MOS device characteristics. These limitations are addressed with circuit techniques discussed in other sections.

Micropower Supply Current and Output Enable

The ISL21060 consumes extremely low supply current due to the proprietary FGA technology. Low noise performance is achieved using optimized biasing techniques. Supply current is typically 16 μA and noise is $10\mu V_{P-P}$, benefitting precision, low noise portable applications, such as handheld meters and instruments.

The ISL21060 devices have the EN pin, which is used to Enable/Disable the output of the device. When disabled, the reference circuitry itself remains biased at a highly accurate and reliable state. When enabled, the output is driven to the reference voltage in a relatively short time (about 300µs). This feature allows multiple references to be connected and one of them selected. Another application is to disable any loads that draw significant current, saving power in standby or shutdown modes.

Board Mounting Considerations

For applications requiring the highest accuracy, board mounting location should be reviewed. The device uses a plastic SOIC package, which will subject the die to mild stresses when the PC board is heated and cooled and slightly changes shape. Placing the device in areas subject to slight twisting can cause degradation of the accuracy of the reference voltage due to these die stresses. It is normally best to place the device near the edge of a board, or the shortest side, as the axis of bending is most limited at that location. Mounting the device in a cutout also minimizes flex. Obviously, mounting the device on flexprint or extremely thin PC material will likewise cause loss of reference accuracy.

Board Assembly Considerations

FGA references provide high accuracy and low temperature drift but some PC board assembly precautions are necessary. Normal Output voltage shifts of 100μV to 1mV can be expected with Pb-free reflow profiles or wave solder on multi-layer FR4 PC boards. Precautions should be taken to avoid excessive heat or extended exposure to high reflow or wave solder temperatures, this may reduce device initial accuracy.

Post-assembly x-ray inspection may also lead to permanent changes in device output voltage and should be minimized or avoided. If x-ray inspection is required, it is advisable to monitor the reference output voltage to verify excessive shift has not occurred. If large amounts of shift are observed, it is best to add an X-ray shield consisting of thin zinc (300 μ m) sheeting to allow clear imaging, yet block x-ray energy that affects the FGA reference.

Special Applications Considerations

In addition to post-assembly examination, there are also other X-ray sources that may affect the FGA reference long term accuracy. Airport screening machines contain X-rays and will have a cumulative effect on the voltage reference output accuracy. Carry-on luggage screening uses low level X-rays and is not a major source of output voltage shift, although if a product is expected to pass through that type of screening over 100 times it may need to consider shielding with copper or aluminum. Checked luggage X-rays are higher intensity and can cause output voltage shift in much fewer passes, so devices expected to go through those machines should definitely consider shielding. Note that just two layers of 1/2 ounce copper planes will reduce the received dose by over 90%. The leadframe for the device which is on the bottom also provides similar shielding.

If a device is expected to pass through luggage X-ray machines numerous times, it is advised to mount a 2-layer (minimum) PC board on the top, and along with a ground plane underneath will effectively shield it from from 50 to 100 passes through the machine. Since these machines vary in X-ray dose delivered, it is difficult to produce an accurate maximum pass recommendation.

Noise Performance and Reduction

The output noise voltage in a 0.1Hz to 10Hz bandwidth is typically $10\mu V_{P-P}$. The noise measurement is made with a bandpass filter made of a 1-pole high-pass filter with a corner frequency at 0.1Hz and a 2-pole low-pass filter with a corner frequency at 12.6Hz to create a filter with a 9.9Hz bandwidth. Noise in the 10kHz to 1MHz bandwidth is approximately $100\mu V_{P-P}$ with no capacitance on the output. This noise measurement is made with a 2 decade bandpass filter made of a 1-pole high-pass filter with a corner frequency at 1/10 of the center frequency and 1-pole low-pass filter with a corner frequency at 10x the center frequency. Load capacitance up to $1\mu F$ can be added to improve transient response.

Turn-On Time

The ISL21060 devices have low supply current and thus the time to bias-up internal circuitry to final values will be longer than with higher power references. Normal turn-on time is typically 300µs. Circuit design must take this into account when looking at power-up delays or sequencing.

Temperature Coefficient

The limits stated for temperature coefficient (tempco) are governed by the method of measurement. The overwhelming standard for specifying the temperature drift of a reference is to measure the reference voltage at two temperatures take the total variation, ($V_{HIGH} - V_{LOW}$), and divide by the temperature extremes of measurement ($T_{HIGH} - T_{LOW}$). The result is divided by the nominal reference voltage (at T = +25°C) and

multiplied by 10⁶ to yield ppm/°C. This is the "Box" method for specifying temperature coefficient.

VOUT Kelvin Sensing

The voltage output for the ISL21060 has both a force and a sense output. This enables remote kevin sensing for highly accurate voltage setting with long traces and higher current loads. The VOUTF (force) can be routed to the load with the shortest, widest trace possible. The VOUTS (sense) is routed with a narrower trace to the point of the actual load where it is connected to the VOUTF trace.

The VOUTF and VOUTS traces must always be connected. If there is only a short trace to the load or even a very light load, then they can be connected at or near the ISL21060 device.

Typical Application Circuits

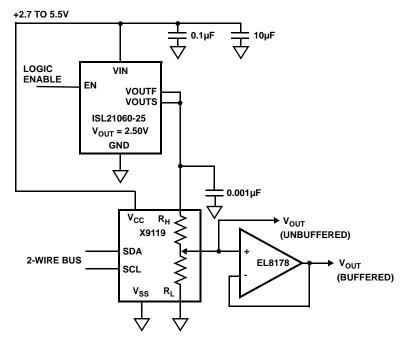
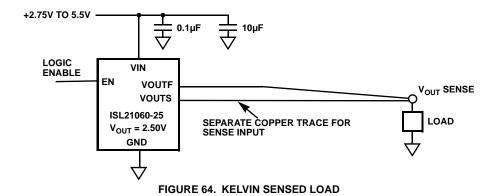
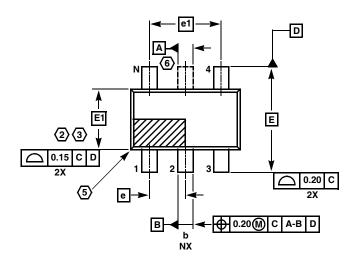


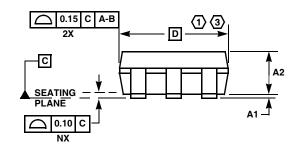
FIGURE 63. 2.5V FULL SCALE LOW-DRIFT, 10-BIT ADJUSTABLE VOLTAGE SOURCE WITH LOW POWER DISABLE

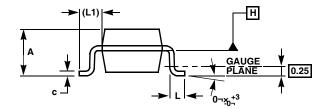


19 <u>intersil</u>

SOT-23 Package Family







MDP0038

SOT-23	PACKAGE	FAMILY

	MILLIMETERS		
SYMBOL	SOT23-5	SOT23-6	TOLERANCE
Α	1.45	1.45	MAX
A1	0.10	0.10	±0.05
A2	1.14	1.14	±0.15
b	0.40	0.40	±0.05
С	0.14	0.14	±0.06
D	2.90	2.90	Basic
E	2.80	2.80	Basic
E1	1.60	1.60	Basic
е	0.95	0.95	Basic
e1	1.90	1.90	Basic
L	0.45	0.45	±0.10
L1	0.60	0.60	Reference
N	5	6	Reference

Rev. F 2/07

NOTES:

- 1. Plastic or metal protrusions of 0.25mm maximum per side are not included.
- Plastic interlead protrusions of 0.25mm maximum per side are not included.
- 3. This dimension is measured at Datum Plane "H".
- 4. Dimensioning and tolerancing per ASME Y14.5M-1994.
- Index area Pin #1 I.D. will be located within the indicated zone (SOT23-6 only).
- 6. SOT23-5 version has no center lead (shown as a dashed line).

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